November 2010

# FAIRCHILD

SEMICONDUCTOR

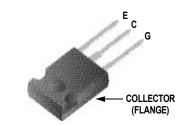
# FGH40N60SMD 600V, 40A Field Stop IGBT

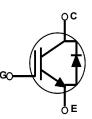
# Features

- Maximum Junction Temperature : T<sub>J</sub> =175°C
- · Positive Temperaure Co-efficient for easy parallel operating
- · High current capability
- Low saturation voltage: V<sub>CE(sat)</sub> =1.9V(Typ.) @ I<sub>C</sub> = 40A
- · High input impedance
- · Fast switching
- Tighten Parameter Distribution
- RoHS compliant

# Applications

- Solar Inverter
- · UPS, Welder, SMPS





Using Novel Field Stop IGBT Technology, Fairchild's new series of Field Stop IGBTs offer the optimum performance for Solar

Inverter, UPS, Welder and SMPS applications where low con-

**General Description** 

duction and switching losses are essential.

# **Absolute Maximum Ratings**

Symbol	Description		Ratings	Units
V <sub>CES</sub>	Collector to Emitter Voltage		600	V
V <sub>GES</sub>	Gate to Emitter Voltage		± 20	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	80	A
.0	Collector Current	@ T <sub>C</sub> = 100°C	40	А
I <sub>CM (1)</sub>	Pulsed Collector Current		120	А
IF	Diode Forward Current	@ T <sub>C</sub> = 25°C	40	A
'F	Diode Forward Current	@ T <sub>C</sub> = 100°C	20	A
I <sub>FM (1)</sub>	Pulsed Diode Maximum Forward Current		120	A
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	349	W
. D	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	174	W
TJ	Operating Junction Temperature		-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

### Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

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# **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{\thetaJC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.43	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	-	1.5	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

# Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGH40N60SMD	FGH40N60SMD	TO-247	-	-	30

# Electrical Characteristics of the IGBT $T_{c} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250μA	600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Temperature Coefficient of Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250μA	-	0.6	-	V/ºC
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±400	nA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_{C} = 250 \mu A, V_{CE} = V_{GE}$	3.5	4.5	6.0	V
		I <sub>C</sub> = 40A, V <sub>GE</sub> = 15V	-	1.9	2.5	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{C} = 40A, V_{GE} = 15V,$ $T_{C} = 175^{\circ}C$	-	2.1	-	v
Dynamic C	haracteristics					

### Dynamic Characteristics

C <sub>ies</sub>	Input Capacitance		-	1880	-	pF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz	-	180	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance		-	50	-	pF

## Switching Characteristics

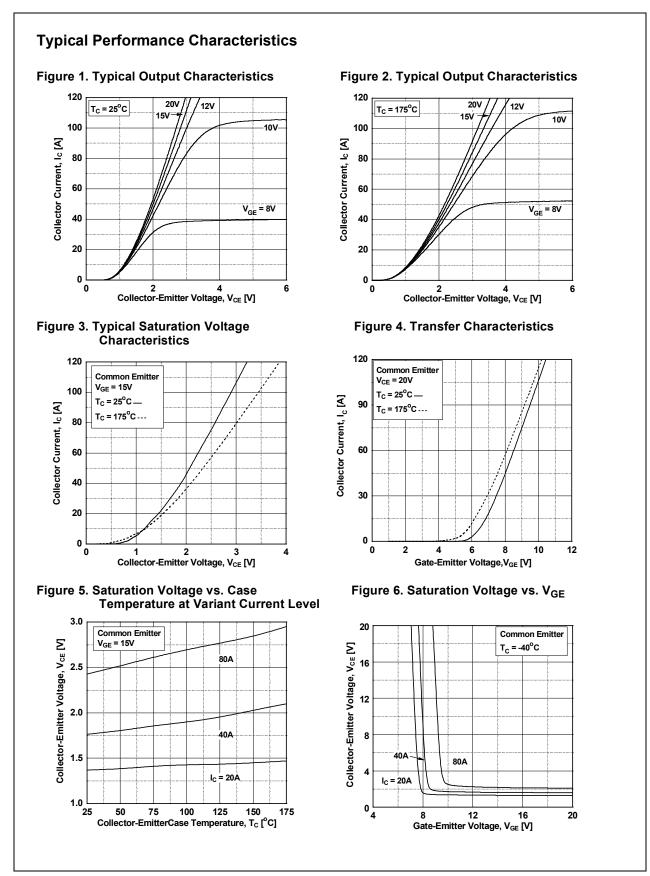
•	.9					
t <sub>d(on)</sub>	Turn-On Delay Time		-	12	16	ns
t <sub>r</sub>	Rise Time		-	20	28	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400V, I <sub>C</sub> = 40A,	-	92	120	ns
t <sub>f</sub>	Fall Time	R <sub>G</sub> = 6Ω, V <sub>GE</sub> = 15V,	-	13	17	ns
Eon	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 25°C	-	0.87	1.30	mJ
E <sub>off</sub>	Turn-Off Switching Loss		-	0.26	0.34	mJ
E <sub>ts</sub>	Total Switching Loss		-	1.13	1.64	mJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	15	-	ns
t <sub>r</sub>	Rise Time		-	22	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400V, I <sub>C</sub> = 40A,	-	116	-	ns
t <sub>f</sub>	Fall Time	$R_G = 6\Omega$ , $V_{GE} = 15V$ ,	-	16	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 175^{\circ}C$	-	0.97	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss		-	0.60	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	1.57	-	mJ

# Electrical Characteristics of the IGBT (Continued)

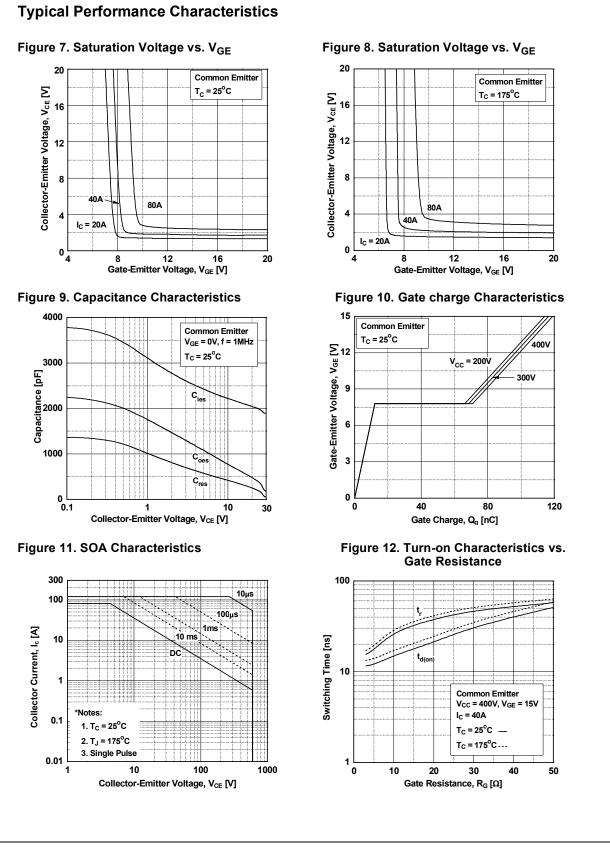
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit s
Qg	Total Gate Charge		-	119	180	nC
Q <sub>ge</sub>	Gate to Emitter Charge	V <sub>CE</sub> = 400V, I <sub>C</sub> = 40A, V <sub>GE</sub> = 15V	-	13	20	nC
Q <sub>gc</sub>	Gate to Collector Charge	VGE - 10V	-	58	90	nC

# **Electrical Characteristics of the Diode** $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditior	าร	Min.	Тур.	Max	Unit s
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 20A	T <sub>C</sub> = 25°C	-	2.3	2.8	V
* F M	Biodo i olivara voltago	1F 2011	T <sub>C</sub> = 175°C	-	1.67	-	
E <sub>rec</sub>	Reverse Recovery Energy		T <sub>C</sub> = 175 <sup>o</sup> C	-	48.9	-	uJ
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> =20A, dI <sub>F</sub> /dt = 200A/μs	T <sub>C</sub> = 25°C	-	36	-	ns
٩r		$1_{\rm F} = 20 \Lambda$ , $0_{\rm F}/01 = 200 \Lambda/\mu S$	T <sub>C</sub> = 175°C	-	110	-	110
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 25 <sup>o</sup> C	-	46.8	-	nC
~II	2.000 Hore to the to th		T <sub>C</sub> = 175°C	-	445	-	

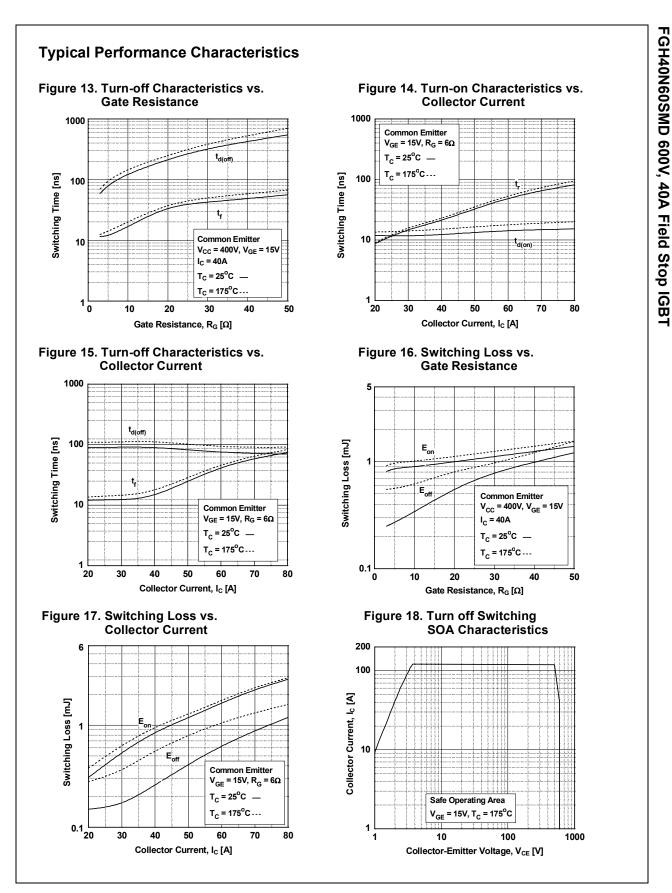


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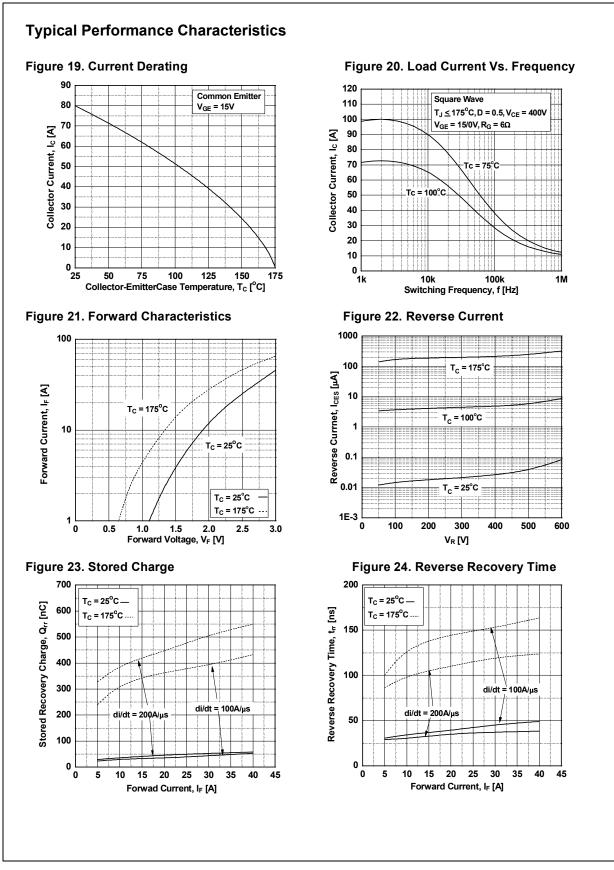


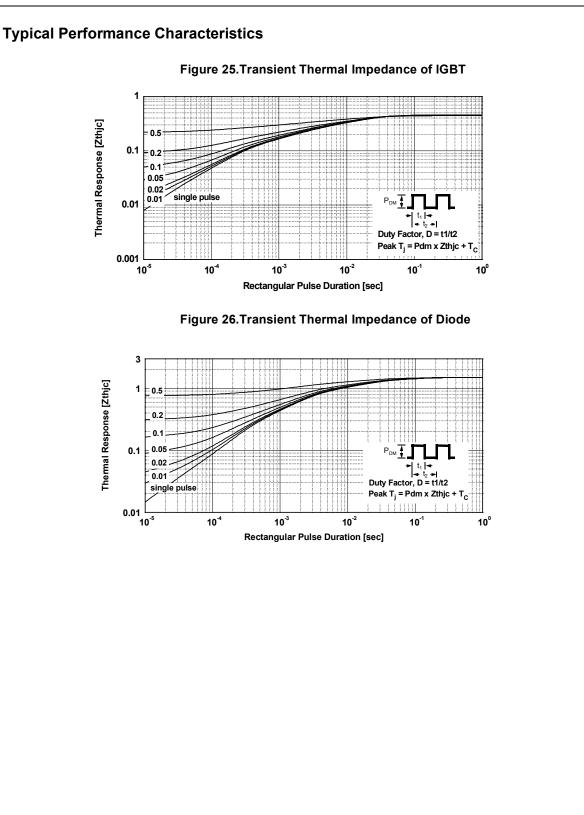
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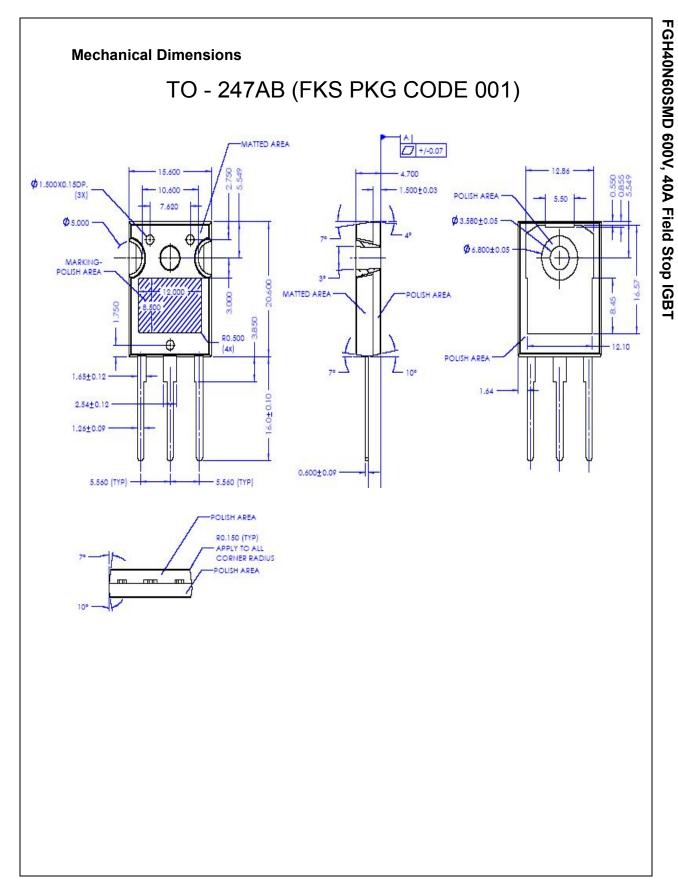
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